

**SF2242B** 

- **40 MHz**

### **Absolute Maximum Ratings**

Compact 40 MHz SAW Filter Design Hermetic 5 x 7 mm Surface-mount Case

Complies with Directive 2002/95/EC (RoHS)

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
DC Voltage on any Non-ground Terminal	5	VDC
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	

Maximum Incident Power in Passband	+10		dBm		/ `	
DC Voltage on any Non-ground Terminal	5		VDC	/		
Storage Temperature Range in Tape and Reel	-40 to +	-85	°C			
Suitable for Lead-free Soldering - Maximum Soldering Profile	2	.60 °C for 3	0 s			
					SMP-03	
Characteristic	Sym	Notes	Min	Тур	Max	Units

Characteristic	Sym	Notes	Min	Тур	Max	Units
Center Frequency	f <sub>C</sub>	1		40		MHz
Minimum insertion Loss	IL <sub>MIN</sub>	1, 2		9.5	12.0	dB
3 dB Bandwidth			3.5	5.0		MHz
Amplitude Ripple, (f <sub>C</sub> - 1.75 MHz to f <sub>C</sub> + 1.75 MHz)				1.4	2.0	dB <sub>P-P</sub>
Group Delay Ripple, (f <sub>C</sub> - 1.75 MHz to f <sub>C</sub> + 1.75 MHz)				190	250	ns <sub>P-P</sub>
Attenuation Relative to IL <sub>MIN</sub> :						
$f_C$ - 5 MHz, $f_C$ + 5 MHz			20	26		
27.5 to 32.5 MHz			31	40		dB
47.5 to 52.5 MHz			31	46		ub ub
0 to 30.0 MHz			35	64		7
50.0 to 70.0 MHz			35	40		
Operating Temperature Range	T <sub>A</sub>	1	-40		+85	°C

Terminating Source Impedance (through matching network)		$Z_S = 50 \text{ ohms}$	
Terminating Source Impedance (through matching network)		$Z_L = 50 \text{ ohms}$	
Case Style		SMP-03 7 x 5 mm Nominal Footprint	
Lid Symbolization (YY = year, WW = week)		RFM/SF2242B/YYWW	

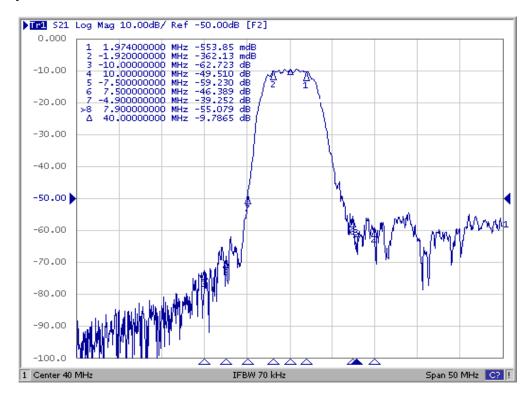


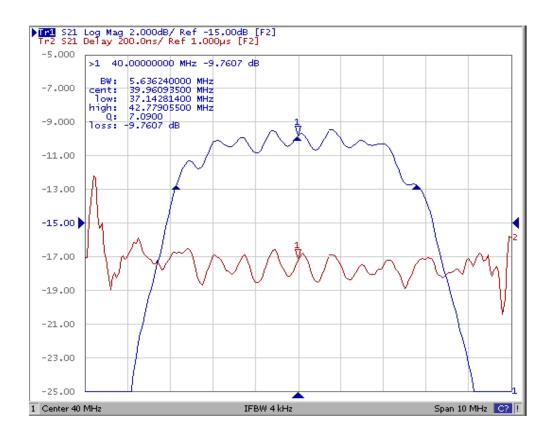
**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.** 

### NOTES:

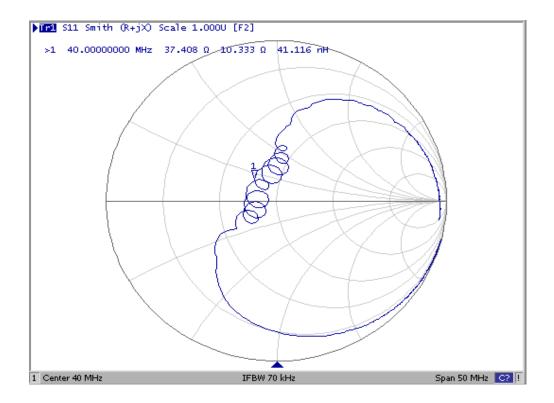
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- The design, manufacturing process, and specifications of this filter are subject to change.
- Tape and Reel Standard ANSI / EIA 481.
- Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- US and international patents may apply.
- Electrostatic Sensitive Device. Observe precautions for handling.
- Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

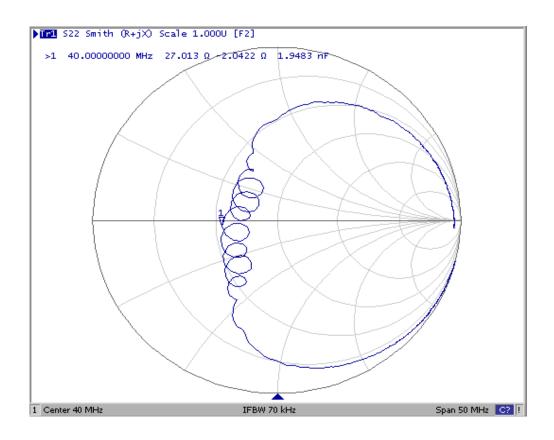
# **Filter Response Plots**



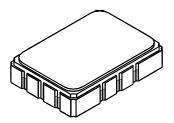


# Filter Input/Output Impedance Plots

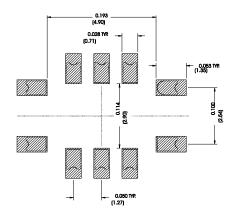




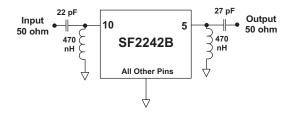
# SMP-03 10-Terminal Ceramic Surface-mount Case 5 x 7 mm Nominal Footprint



## **Recommended PCB Footprint**



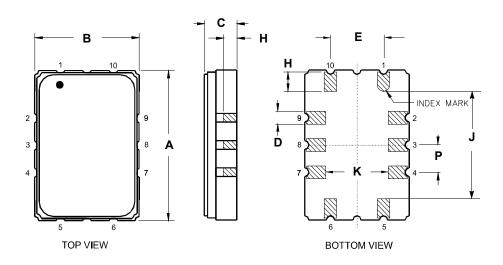
### **Matching Circuit**



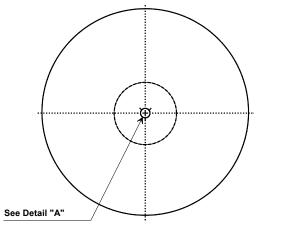
Case Dimensions						
Dimension		mm			Inches	
	Min	Nom	Max	Min	Nom	Max
Α	6.80	7.00	7.20	0.268	0.276	0.283
В	4.80	5.00	5.20	0.189	0.197	0.205
С	-	1.65	2.00	-	0.065	0.079
D	0.47	0.60	0.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
Н	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
Р	1.14	1.27	1.40	0.045	0.050	0.055

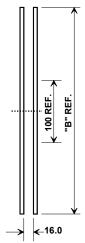
Electrical Connections				
Single-Ended Connection	Terminals			
Input	10			
Output	5			
Ground	All others			
Differential Connection	Terminals			
Input	10, 1			
Output	5, 6			
Ground	All others			

Case Materials				
Solder Pad Plating	0.3 to 1.0 µm Gold over 1.27 to 8.89 µm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				

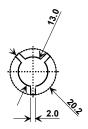


# **Tape and Reel Specifications**





"B" Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000



### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions				
Ao	5.6 mm			
Во	7.6 mm			
Ko	2.0 mm			
Pitch	8.0 mm			
W	16.0 mm			

